Supplier Name:	Texas Instruments Inc. (DUNS# 00-732-1904)
Contact Info:	ti.com/support
Form/Declaration Type:	Distribute - RoHS and IEC 62474 DB
Created on:	06/12/2022

Details for "TPS77701DR"

### **Current Product Information**

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package   Pins	Package body size (mm)	Total device mass (mg)*
TPS77701DR	NIPDAU	Level-1-260C-UNLIM	TI TAIWAN A/T	D   8	3.91x4.9x1.58	146.4

### \*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

### **Environmental Ratings Information**

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

### **Component Information**

			Homogeneous Material Level		Component Level		
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Copper and Its Alloys	Copper	7440-50-8	0.038089	99.989499	999895	0.026017	260
Not Categorized	Proprietary Materials		0.000003	0.007875	79	0.000002	0
Precious Metals	Silver	7440-22-4	0.000001	0.002625	26	0.000001	0
Sub-Total			0.038093	100	1000000	0.026019	260
Die Attach Adhesive	-		•				
Precious Metals	Silver	7440-22-4	0.665911	79.999976	800000	0.45485	4548
Thermoplastics	Ероху	85954-11-6	0.166478	20.000024	200000	0.113713	1137
Sub-Total			0.832389	100	1000000	0.568563	5686
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	81.725805	97.05	970500	55.822741	558227
Copper and Its Alloys	Iron	7439-89-6	2.18946	2.6	26000	1.495509	14955
Copper and Its Alloys	Phosphorus	7723-14-0	0.126315	0.15	1500	0.086279	863
Zinc and Its Alloys	Zinc	7440-66-6	0.16842	0.2	2000	0.115039	1150
Sub-Total			84.21	100	1000000	57.519569	575196
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	0.28536	95.12	951200	0.194915	1949
Precious Metals	Gold	7440-57-5	0.00234	0.78	7800	0.001598	16
Precious Metals	Palladium	7440-05-3	0.0123	4.1	41000	0.008402	84
Sub-Total			0.3	100	1000000	0.204915	2049
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	51.304563	88	880000	35.043538	350435
Other Plastics and Rubber	Carbon Black	1333-86-4	0.174902	0.3	3000	0.119467	1195
Other Plastics and Rubber	Organic Phosphorus	1330-78-5	0.320654	0.550001	5500	0.219022	2190
Thermoplastics	Ероху	85954-11-6	6.500521	11.149999	111500	4.440175	44402
Sub-Total			58.30064	100	1000000	39.822202	398222
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	2.721228	100	1000000	1.858732	18587
Sub-Total			2.721228	100	1000000	1.858732	18587
Total			146 40005			100	1000000
Total			146.40235			100	1000000

#### Important Note

The ppm calculations are at the **homogeneous material** level and are maximum concentration values. The ppm displayed represents the **homogeneous material** with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component.

See Glossary of Terms for more details.

### **Important Part Information**

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

# **Product Content Methodology**

For an explanation of the methods used to determine material weights, See Product Content Methodology

# Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

# Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/12/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (Cl) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.